RGW00TK65DGVC11

650V 50A Field Stop Trench IGBT Datasheet

V_{CES}	650V
$I_{C\ (100℃)}$	26A
$V_{CE(sat)\ (Typ.)}$	1.5V@I_C=50A
P_D	89W

●Outline

TO-3PFM

●Features

1) Low Collector - Emitter Saturation Voltage

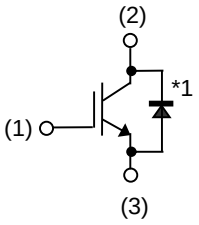
2) High Speed Switching

3) Low Switching Loss & Soft Switching

4) Built in Very Fast & Soft Recovery FRD

5) Pb - free Lead Plating ; RoHS Compliant

●Inner Circuit



(1) Gate
(2) Collector
(3) Emitter

*1 Built in FRD

●Applications

PFC

UPS

Welding

Solar Inverter

IH

●Packaging Specifications

Type	Packaging	Tube
	Reel Size (mm)	-
	Tape Width (mm)	-
	Basic Ordering Unit (pcs)	450
	Packing Code	C11
	Marking	RGW00TK65D

●Absolute Maximum Ratings (at T_C = 25°C unless otherwise specified)

Parameter		Symbol	Value	Unit
Collector - Emitter Voltage		V_{CES}	650	V
Gate - Emitter Voltage		V_{GES}	±30	V
Collector Current	T_C = 25°C	I_C	45	A
	T_C = 100°C	I_C	26	A
Pulsed Collector Current		I_{CP} *1	200	A
Diode Forward Current	T_C = 25°C	I_F	34	A
	T_C = 100°C	I_F	19	A
Diode Pulsed Forward Current		I_{FP} *1	200	A
Power Dissipation	T_C = 25°C	P_D	89	W
	T_C = 100°C	P_D	44	W
Operating Junction Temperature		T_j	−40 to +175	°C
Storage Temperature		T_{stg}	−55 to +175	°C

*1 Pulse width limited by T_{jmax}.

●Thermal Resistance

Parameter	Symbol	Values			Unit
		Min.	Typ.	Max.	
Thermal Resistance IGBT Junction - Case	$R_{\theta(j-c)}$	-	-	1.67	°C/W
Thermal Resistance Diode Junction - Case	$R_{\theta(j-c)}$	-	-	2.29	°C/W

●IGBT Electrical Characteristics (at T_j = 25°C unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Collector - Emitter Breakdown Voltage	BV_{CES}	I_C = 10μA, V_{GE} = 0V	650	-	-	V
Collector Cut - off Current	I_{CES}	V_{CE} = 650V, V_{GE} = 0V	-	-	10	μA
Gate - Emitter Leakage Current	I_{GES}	V_{GE} = ±30V, V_{CE} = 0V	-	-	±200	nA
Gate - Emitter Threshold Voltage	$V_{GE(th)}$	V_{CE} = 5V, I_C = 33.0mA	5.0	6.0	7.0	V
Collector - Emitter Saturation Voltage	$V_{CE(sat)}$	I_C = 50A, V_{GE} = 15V				V
		T_j = 25°C	-	1.5	1.9	
		T_j = 175°C	-	1.85	-	

●**IGBT Electrical Characteristics** (at T_j = 25°C unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Input Capacitance	C_{ies}	V_{CE} = 30V	-	4200	-	pF
Output Capacitance	C_{oes}	V_{GE} = 0V	-	104	-	
Reverse Transfer Capacitance	C_{res}	f = 1MHz	-	79	-	
Total Gate Charge	Q_g	V_{CE} = 400V	-	141	-	nC
Gate - Emitter Charge	Q_{ge}	I_C = 50A	-	30	-	
Gate - Collector Charge	Q_{gc}	V_{GE} = 15V	-	52	-	
Turn - on Delay Time	$t_{d(on)}$	I_C = 50A, V_{CC} = 400V	-	52	-	ns
Rise Time	t_r	V_{GE} = 15V, R_G = 10Ω	-	21	-	
Turn - off Delay Time	$t_{d(off)}$	T_j = 25°C	-	180	-	
Fall Time	t_f	Inductive Load	-	33	-	
Turn - on Switching Loss	E_{on}	*E_{on} includes diode	-	1.18	-	mJ
Turn - off Switching Loss	E_{off}	reverse recovery	-	0.96	-	
Turn - on Delay Time	$t_{d(on)}$	I_C = 50A, V_{CC} = 400V	-	49	-	ns
Rise Time	t_r	V_{GE} = 15V, R_G = 10Ω	-	23	-	
Turn - off Delay Time	$t_{d(off)}$	T_j = 175°C	-	201	-	
Fall Time	t_f	Inductive Load	-	72	-	
Turn - on Switching Loss	E_{on}	*E_{on} includes diode	-	1.18	-	mJ
Turn - off Switching Loss	E_{off}	reverse recovery	-	1.18	-	
Reverse Bias Safe Operating Area	RBSOA	I_C = 200A, V_{CC} = 520V V_P = 650V, V_{GE} = 15V R_G = 100Ω, T_j = 175°C	FULL SQUARE			-

●**FRD Electrical Characteristics** (at T_j = 25°C unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Diode Forward Voltage	V_F	I_F = 30A T_j = 25°C T_j = 175°C	- -	1.45 1.55	1.9 -	V
Diode Reverse Recovery Time	t_{rr}	I_F = 30A V_{CC} = 400V di_F/dt = 200A/µs T_j = 25°C	-	95	-	ns
Diode Peak Reverse Recovery Current	I_{rr}		-	8.1	-	A
Diode Reverse Recovery Charge	Q_{rr}		-	0.42	-	µC
Diode Reverse Recovery Energy	E_{rr}		-	19.3	-	µJ
Diode Reverse Recovery Time	t_{rr}	I_F = 30A V_{CC} = 400V di_F/dt = 200A/µs T_j = 175°C	-	155	-	ns
Diode Peak Reverse Recovery Current	I_{rr}		-	10.4	-	A
Diode Reverse Recovery Charge	Q_{rr}		-	0.95	-	µC
Diode Reverse Recovery Energy	E_{rr}		-	62.5	-	µJ

●Electrical Characteristic Curves

Fig.1 Power Dissipation vs. Case Temperature

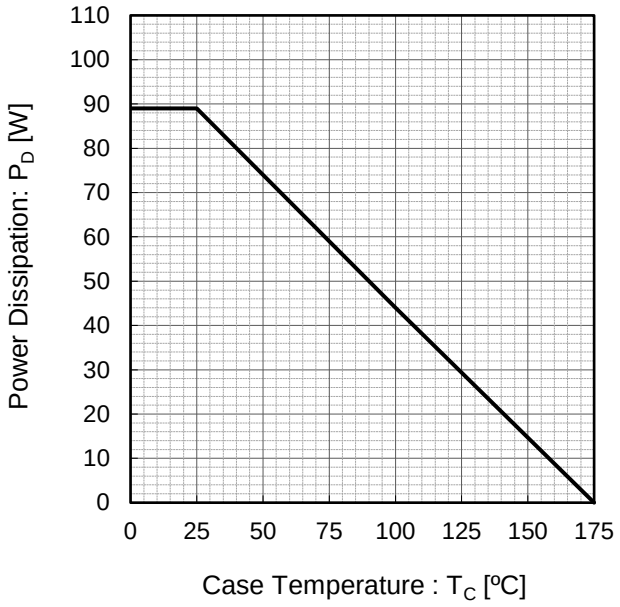


Fig.2 Collector Current vs. Case Temperature

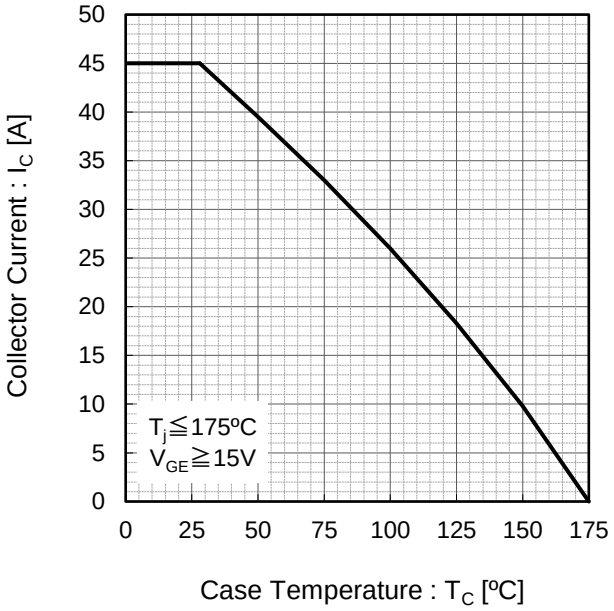


Fig.3 Forward Bias Safe Operating Area

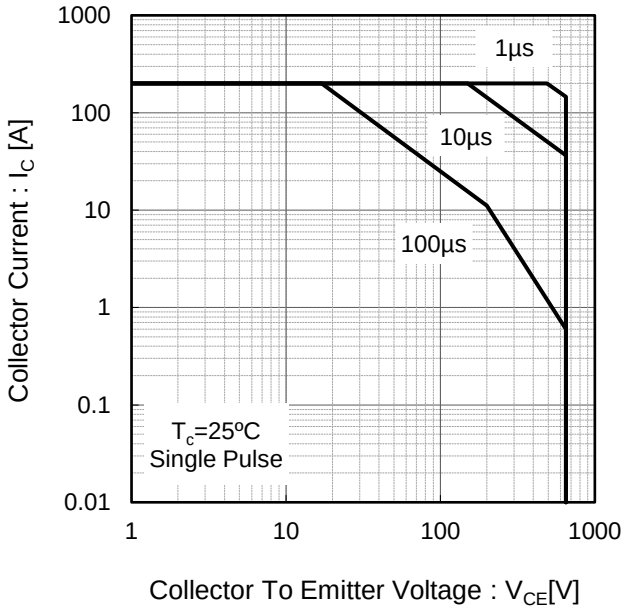
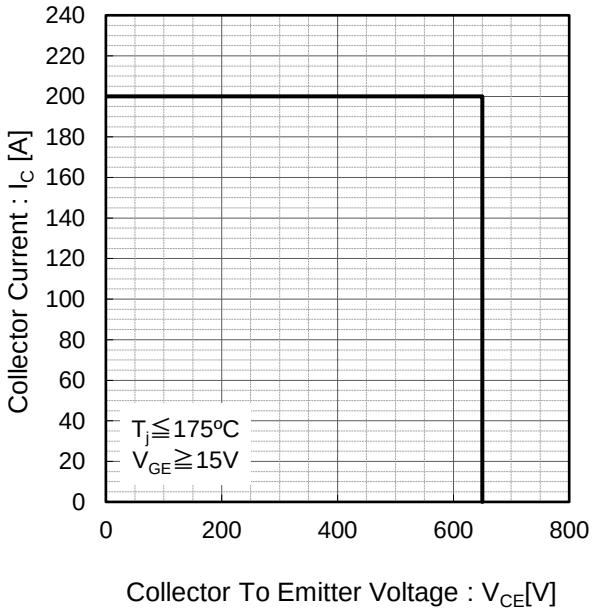


Fig.4 Reverse Bias Safe Operating Area



●Electrical Characteristic Curves

Fig.5 Typical Output Characteristics

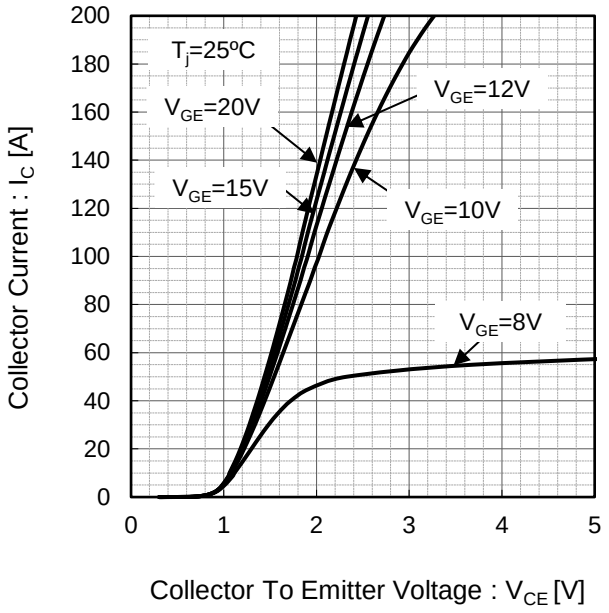


Fig.6 Typical Output Characteristics

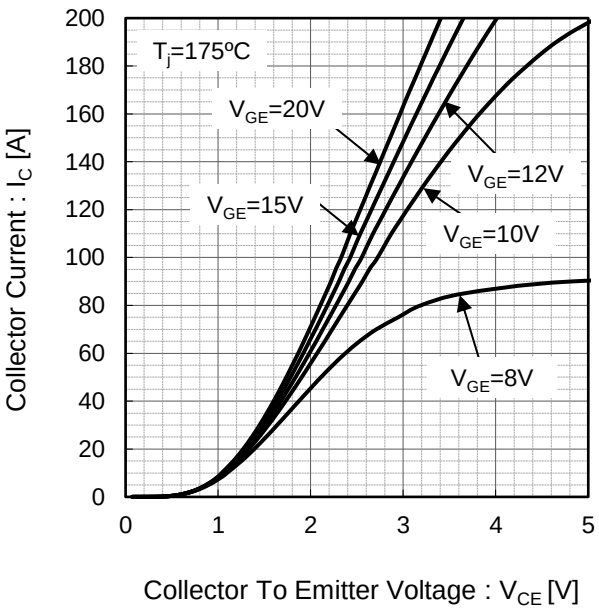


Fig.7 Typical Transfer Characteristics

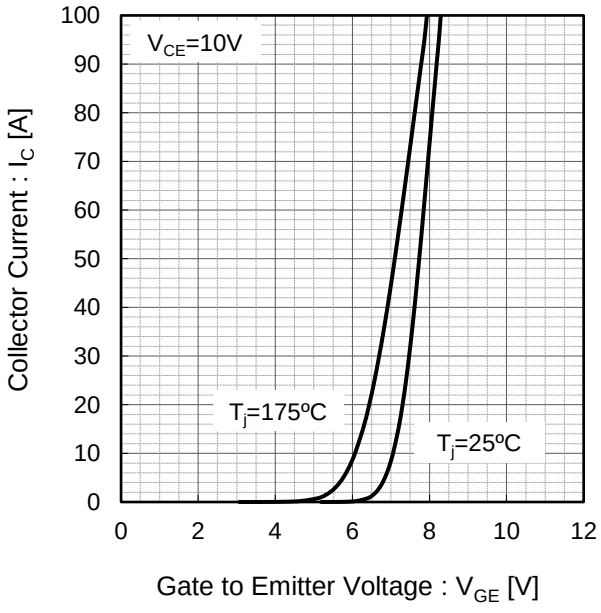
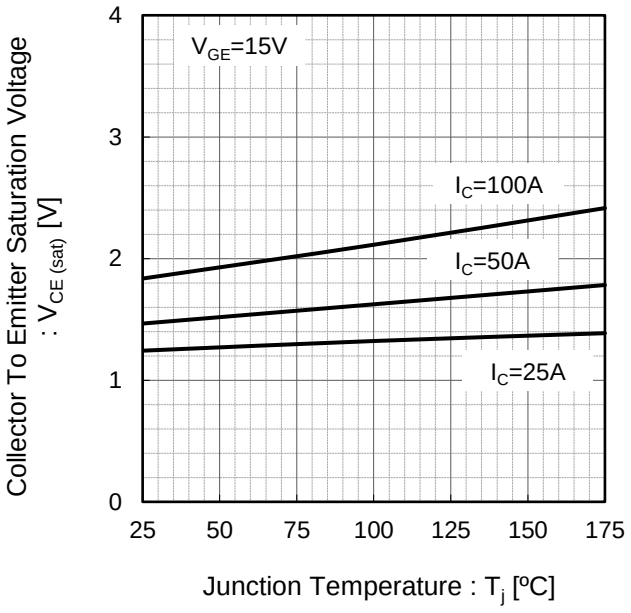


Fig.8 Typical Collector To Emitter Saturation Voltage vs. Junction Temperature



●Electrical Characteristic Curves

Fig.9 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage

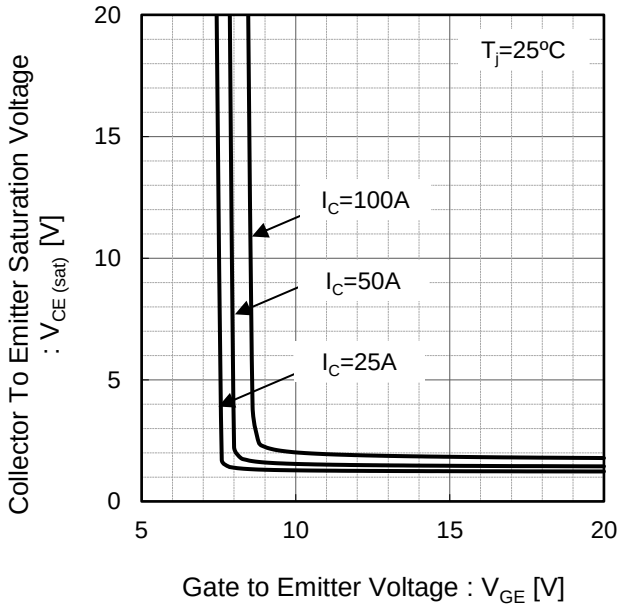


Fig.10 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage

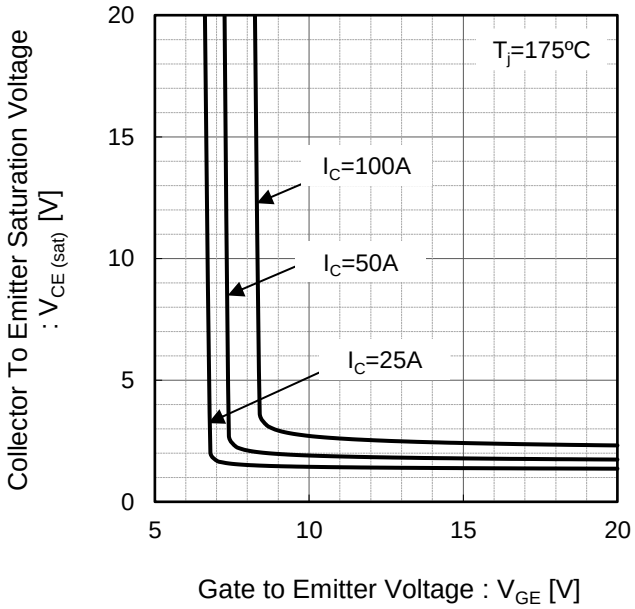


Fig.11 Typical Switching Time vs. Collector Current

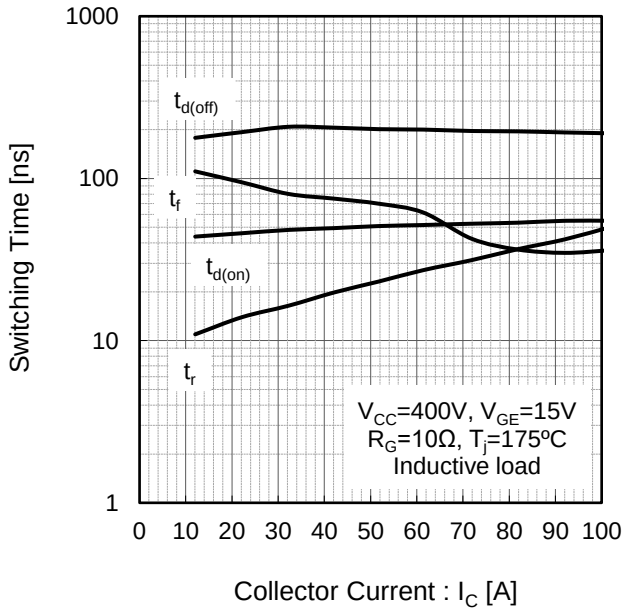
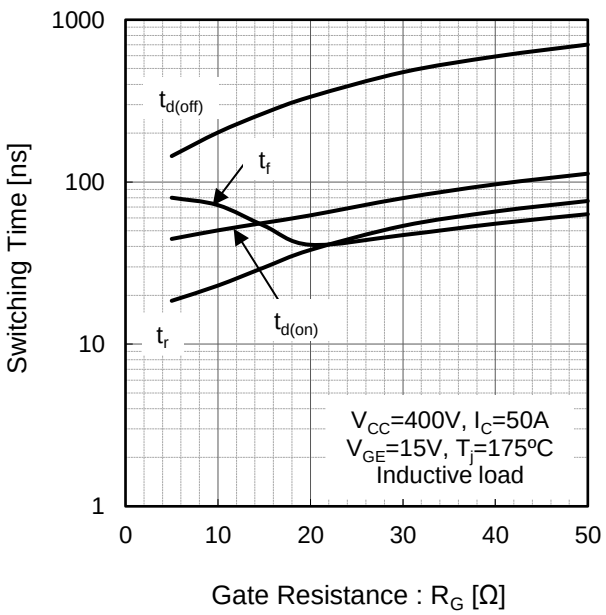


Fig.12 Typical Switching Time vs. Gate Resistance



●Electrical Characteristic Curves

Fig.13 Typical Switching Energy Losses vs. Collector Current

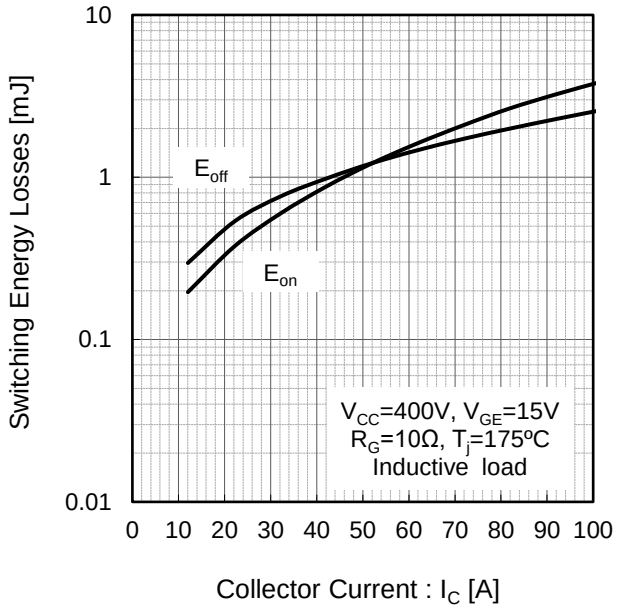


Fig.14 Typical Switching Energy Losses vs. Gate Resistance

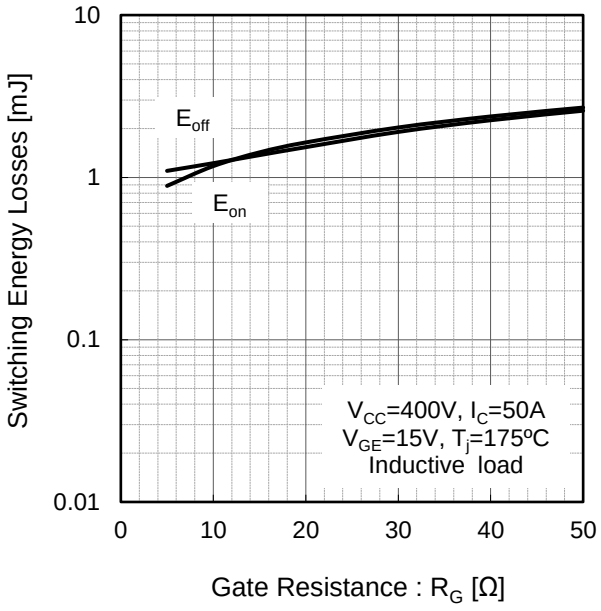


Fig.15 Typical Capacitance vs. Collector To Emitter Voltage

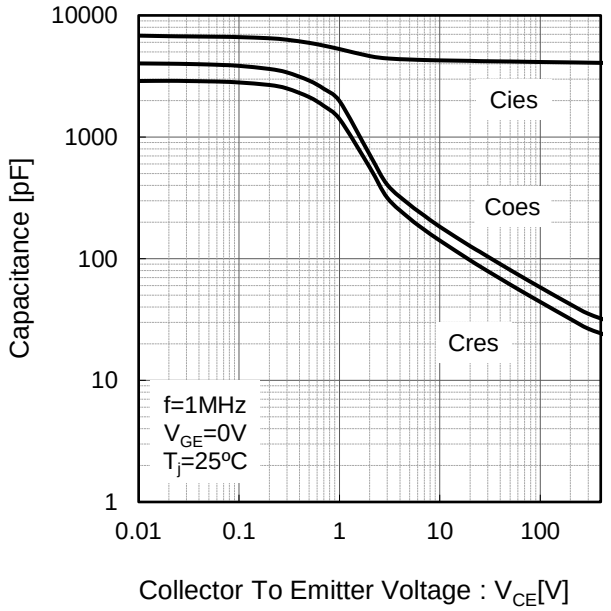
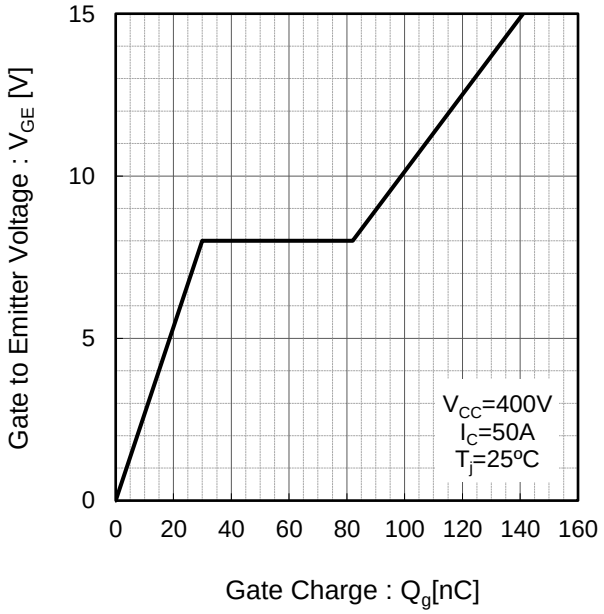


Fig.16 Typical Gate Charge



●Electrical Characteristic Curves

Fig.17 Typical Diode Forward Current vs. Forward Voltage

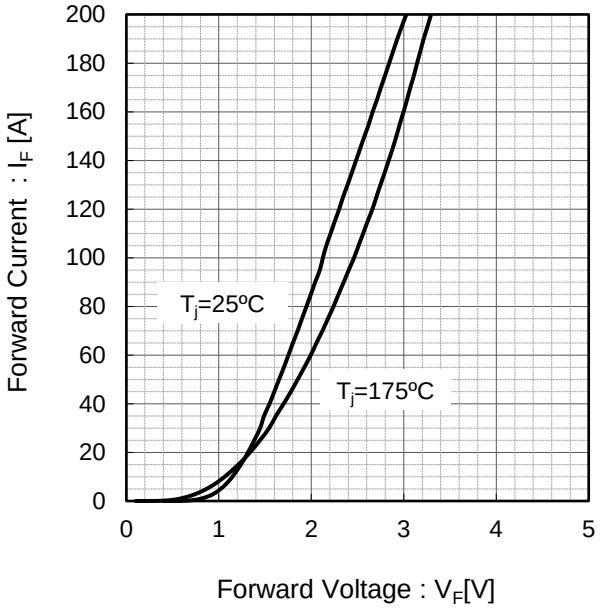


Fig.18 Typical Diode Reverse Recovery Time vs. Forward Current

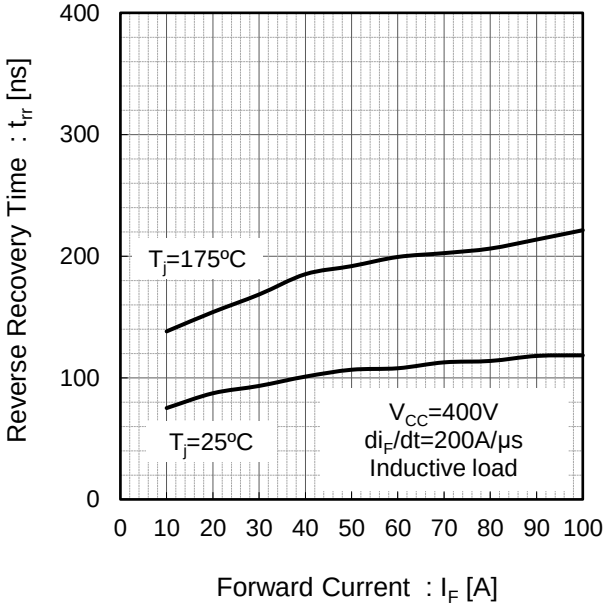


Fig.19 Typical Diode Reverse Recovery Current vs. Forward Current

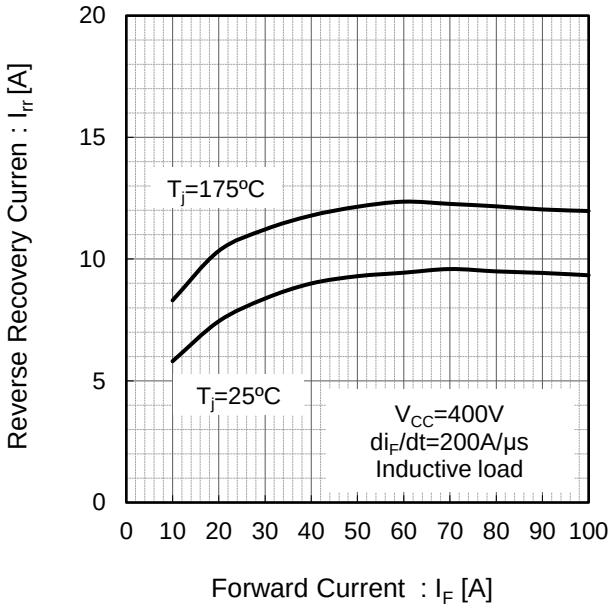
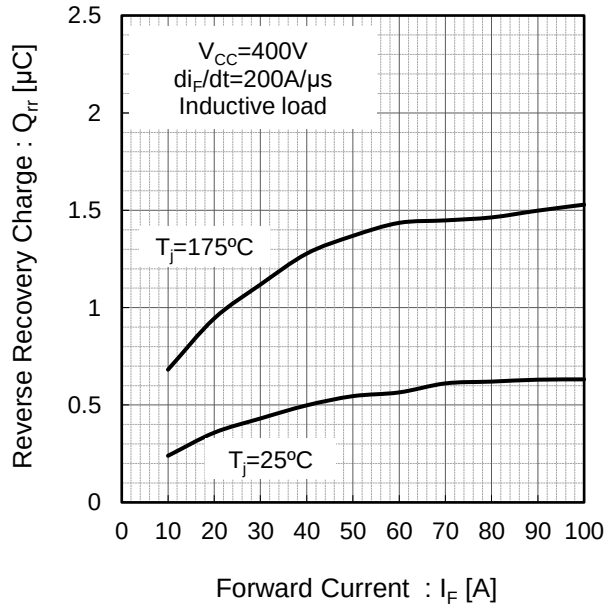
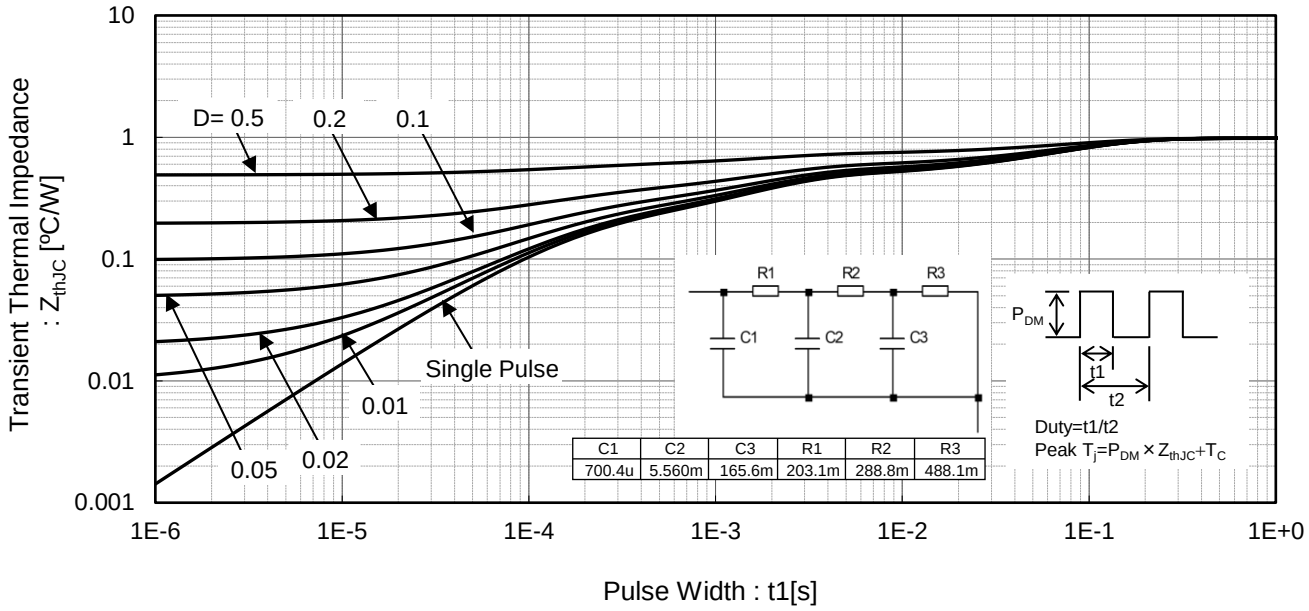


Fig.20 Typical Diode Reverse Recovery Charge



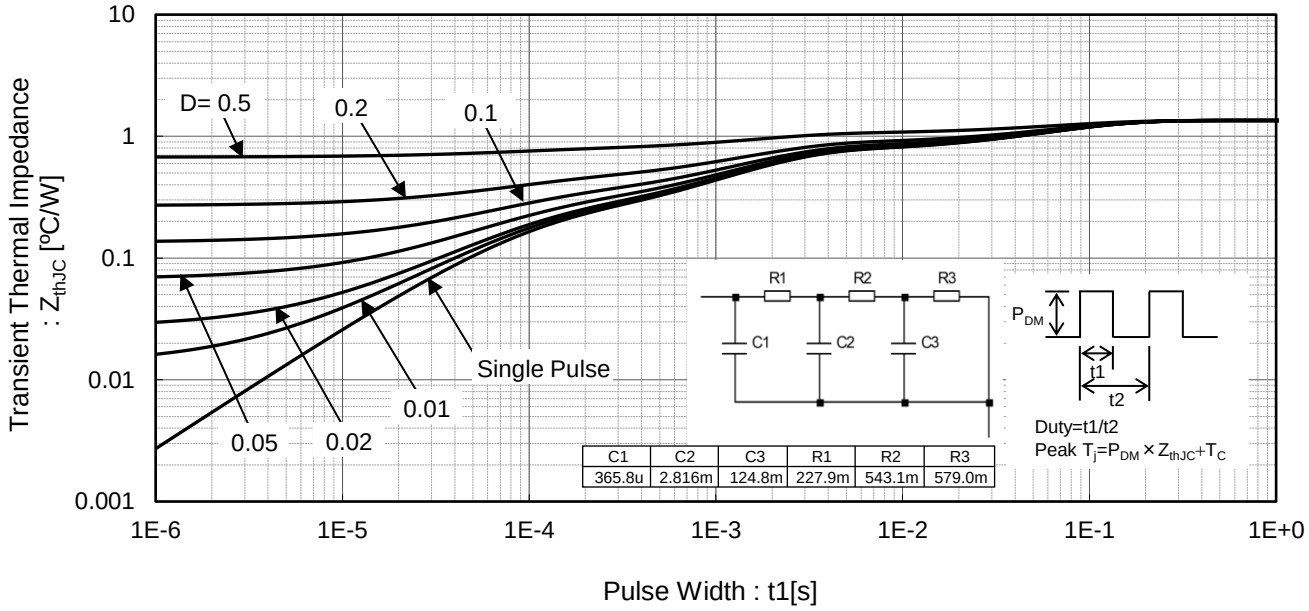
●Electrical Characteristic Curves

Fig.21 Typical IGBT Transient Thermal Impedance



C1	C2	C3	R1	R2	R3
700.4u	5.560m	165.6m	203.1m	288.8m	488.1m

Fig.22 Typical Diode Transient Thermal Impedance



C1	C2	C3	R1	R2	R3
365.8u	2.816m	124.8m	227.9m	543.1m	579.0m

●Inductive Load Switching Circuit and Waveform

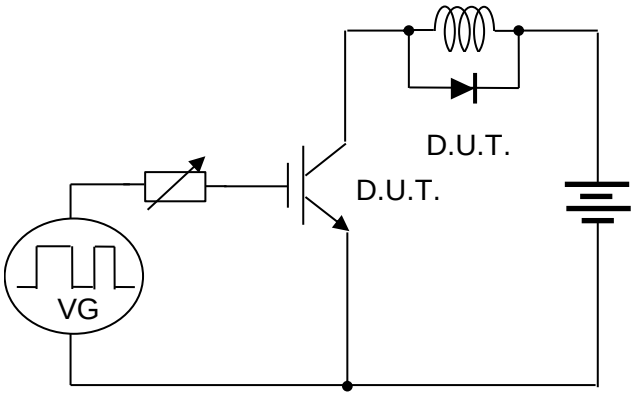


Fig.23 Inductive Load Circuit

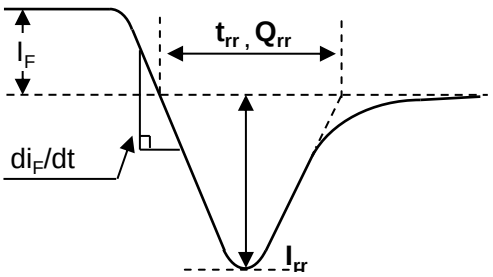


Fig.25 Diode Reverce Recovery Waveform

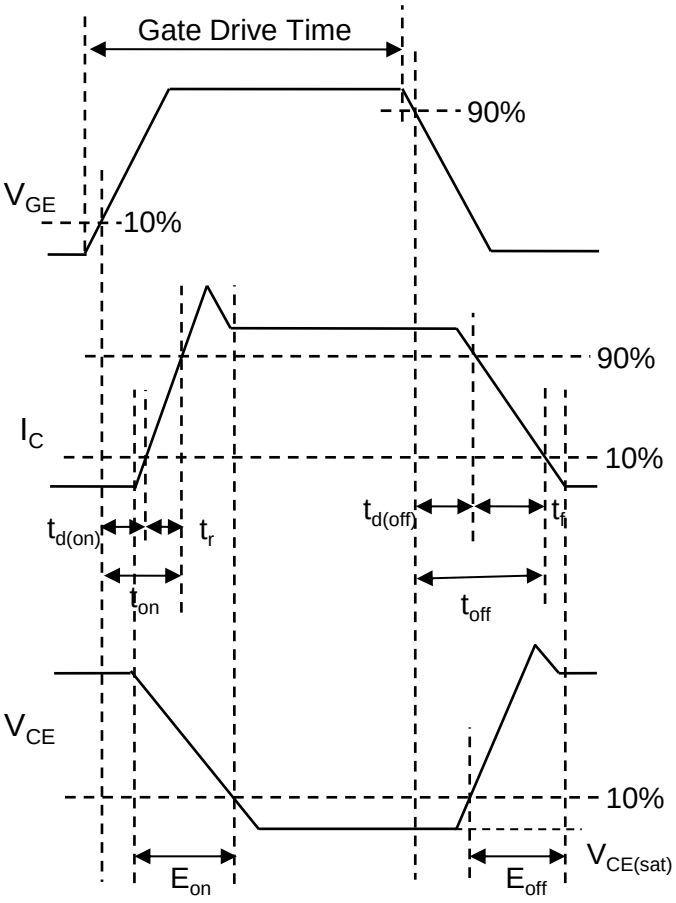


Fig.24 Inductive Load Waveform

Notes

1) The information contained herein is subject to change without notice.

2) Before you use our Products, please contact our sales representative and verify the latest specifications.

3) Although ROHM is continuously working to improve product reliability and quality, semiconductors can break down and malfunction due to various factors.
Therefore, in order to prevent personal injury or fire arising from failure, please take safety measures such as complying with the derating characteristics, implementing redundant and fire prevention designs, and utilizing backups and fail-safe procedures. ROHM shall have no responsibility for any damages arising out of the use of our Poducts beyond the rating specified by ROHM.

4) Examples of application circuits, circuit constants and any other information contained herein are provided only to illustrate the standard usage and operations of the Products. The peripheral conditions must be taken into account when designing circuits for mass production.

5) The technical information specified herein is intended only to show the typical functions of and examples of application circuits for the Products. ROHM does not grant you, explicitly or implicitly, any license to use or exercise intellectual property or other rights held by ROHM or any other parties. ROHM shall have no responsibility whatsoever for any dispute arising out of the use of such technical information.

6) The Products specified in this document are not designed to be radiation tolerant.

7) For use of our Products in applications requiring a high degree of reliability (as exemplified below), please contact and consult with a ROHM representative : transportation equipment (i.e. cars, ships, trains), primary communication equipment, traffic lights, fire/crime prevention, safety equipment, medical systems, and power transmission systems.

8) Do not use our Products in applications requiring extremely high reliability, such as aerospace equipment, nuclear power control systems, and submarine repeaters.

9) ROHM shall have no responsibility for any damages or injury arising from non-compliance with the recommended usage conditions and specifications contained herein.

10) ROHM has used reasonable care to ensure the accuracy of the information contained in this document. However, ROHM does not warrants that such information is error-free, and ROHM shall have no responsibility for any damages arising from any inaccuracy or misprint of such information.

11) Please use the Products in accordance with any applicable environmental laws and regulations, such as the RoHS Directive. For more details, including RoHS compatibility, please contact a ROHM sales office. ROHM shall have no responsibility for any damages or losses resulting non-compliance with any applicable laws or regulations.

12) When providing our Products and technologies contained in this document to other countries, you must abide by the procedures and provisions stipulated in all applicable export laws and regulations, including without limitation the US Export Administration Regulations and the Foreign Exchange and Foreign Trade Act.

13) This document, in part or in whole, may not be reprinted or reproduced without prior consent of ROHM.

ROHM SEMICONDUCTOR

Thank you for your accessing to ROHM product informations.
More detail product informations and catalogs are available, please contact us.

ROHM Customer Support System

http://www.rohm.com/contact/

General Precaution

1. Before you use our Products, you are requested to carefully read this document and fully understand its contents. ROHM shall not be in any way responsible or liable for failure, malfunction or accident arising from the use of any ROHM's Products against warning, caution or note contained in this document.

2. All information contained in this document is current as of the issuing date and subject to change without any prior notice. Before purchasing or using ROHM's Products, please confirm the latest information with a ROHM sales representative.

3. The information contained in this document is provided on an "as is" basis and ROHM does not warrant that all information contained in this document is accurate and/or error-free. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties resulting from inaccuracy or errors of or concerning such information.